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TRANSMITTAL FORM (to be used for all correspondence after initial filing)	Application Number	10/612,112
	Filing Date	08/02/2003
	First Named Inventor	Jacob Fraden
	Art Unit	2859
	Examiner Name	Verbitsky, Gail Kaplan
9 &	Attorney Docket Number	

28 Total Number of Pages in This Submission **ENCLOSURES** (Check all that apply) After Allowance communication Fee Transmittal Form Drawing(s) to Technology Center (TC) Appeal Communication to Board Licensing-related Papers Fee Attached of Appeals and Interferences Appeal Communication to TC V Petition Amendment/Reply (Appeal Notice, Brief, Reply Brief) Petition to Convert to a Proprietary Information After Final **Provisional Application** Power of Attorney, Revocation Status Letter Affidavits/declaration(s) Change of Correspondence Address Other Enclosure(s) (please **Terminal Disclaimer** Extension of Time Request Identify below): Request for Refund Express Abandonment Request CD, Number of CD(s) Information Disclosure Statement Remarks Certified Copy of Priority Document(s) Desponse to communication of 09/14/2004 Response to Missing Parts/ Incomplete Application Response to Missing Parts under 37 CFR 1.52 or 1.53 SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT Firm Jacob Fraden, Advanced Monitors Corporation Individual name Signature

CERTIFICATE OF TRANSMISSION/MAILING

Date

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In The Claims:

This listing of claims will replace all prior versions and listings of respective claims in the application:

- 1. (Currently Amended) A probe of a medical instrument that is intended for insertion into a patient's body orifice, such probe has <u>an inner surface</u> and the outer surface which is shaped to contain at least one cavity <u>encircled by a ridge</u>.
- 2. (Currently Amended) A probe of claim 1 where said cavity is covered by outer thin skin that is permanently attached to said outer surface ridge.
- 3. (Cancelled)
- 4. (Currently Amended) A probe of claim 3 1 where said which contains multiple cavities being are randomly distributed along said outer surface.
- 5. (Original) A probe of claim 1 is fabricated of material having low thermal conductivity
- 6. (Original) A probe of claim 1 further comprises a polymer probe cover that envelopes said outer surface.
- 7. (Original) A method of thermal insulation of a medical probe, comprising a step of forming indentations on the outer surface of the probe.
- 8. (Currently Amended) A method of thermal insulation of a medical probe of claim 7, further comprising a step of covering said indentations with a layer of <u>thin</u> protective material having low thermal conductivity.